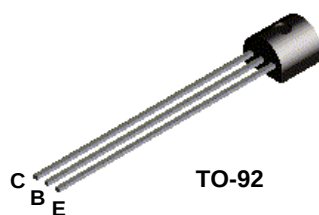
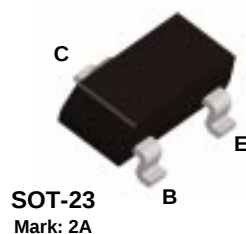


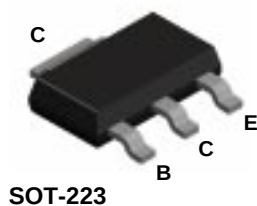
2N3906



MMBT3906



PZT3906



PNP General Purpose Amplifier

This device is designed for general purpose amplifier and switching applications at collector currents of 10 μ A to 100 mA. Sourced from Process 66.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	40	V
V _{CBO}	Collector-Base Voltage	40	V
V _{EBO}	Emitter-Base Voltage	5.0	V
I _C	Collector Current - Continuous	200	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

PNP General Purpose Amplifier

(continued)

Electrical Characteristics

TA = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
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OFF CHARACTERISTICS

$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage*	$I_C = 1.0 \text{ mA}$, $I_B = 0$	40		V
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage	$I_C = 10 \text{ }\mu\text{A}$, $I_E = 0$	40		V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	$I_E = 10 \text{ }\mu\text{A}$, $I_C = 0$	5.0		V
I_{BL}	Base Cutoff Current	$V_{CE} = 30 \text{ V}$, $V_{BE} = 3.0 \text{ V}$		50	nA
I_{CEX}	Collector Cutoff Current	$V_{CE} = 30 \text{ V}$, $V_{BE} = 3.0 \text{ V}$		50	nA

ON CHARACTERISTICS

h_{FE}	DC Current Gain *	$I_C = 0.1 \text{ mA}$, $V_{CE} = 1.0 \text{ V}$ $I_C = 1.0 \text{ mA}$, $V_{CE} = 1.0 \text{ V}$ $I_C = 10 \text{ mA}$, $V_{CE} = 1.0 \text{ V}$ $I_C = 50 \text{ mA}$, $V_{CE} = 1.0 \text{ V}$ $I_C = 100 \text{ mA}$, $V_{CE} = 1.0 \text{ V}$	60 80 100 60 30	300	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 10 \text{ mA}$, $I_B = 1.0 \text{ mA}$ $I_C = 50 \text{ mA}$, $I_B = 5.0 \text{ mA}$		0.25 0.4	V V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = 10 \text{ mA}$, $I_B = 1.0 \text{ mA}$ $I_C = 50 \text{ mA}$, $I_B = 5.0 \text{ mA}$	0.65	0.85 0.95	V V

SMALL SIGNAL CHARACTERISTICS

f_T	Current Gain - Bandwidth Product	$I_C = 10 \text{ mA}$, $V_{CE} = 20 \text{ V}$, $f = 100 \text{ MHz}$	250		MHz
C_{obo}	Output Capacitance	$V_{CB} = 5.0 \text{ V}$, $I_E = 0$, $f = 100 \text{ kHz}$		4.5	pF
C_{ibo}	Input Capacitance	$V_{EB} = 0.5 \text{ V}$, $I_C = 0$, $f = 100 \text{ kHz}$		10.0	pF
NF	Noise Figure (except MMPQ3906)	$I_C = 100 \text{ }\mu\text{A}$, $V_{CE} = 5.0 \text{ V}$, $R_S = 1.0 \text{ k}\Omega$, $f = 10 \text{ Hz to } 15.7 \text{ kHz}$		4.0	dB

SWITCHING CHARACTERISTICS (except MMPQ3906)

t_d	Delay Time	$V_{CC} = 3.0 \text{ V}$, $V_{BE} = 0.5 \text{ V}$,		35	ns
t_r	Rise Time	$I_C = 10 \text{ mA}$, $I_{B1} = 1.0 \text{ mA}$		35	ns
t_s	Storage Time	$V_{CC} = 3.0 \text{ V}$, $I_C = 10 \text{ mA}$		225	ns
t_f	Fall Time	$I_{B1} = I_{B2} = 1.0 \text{ mA}$		75	ns

*Pulse Test: Pulse Width $\leq 300 \text{ }\mu\text{s}$, Duty Cycle $\leq 2.0\%$

Spice Model

PNP (Is=1.41f Xti=3 Eg=1.11 Vaf=18.7 Bf=180.7 Ne=1.5 Ise=0 Ikf=80m Xtb=1.5 Br=4.977 Nc=2 Isc=0 Ikr=0 Rc=2.5 Cjc=9.728p Mjc=.5776 Vjc=.75 Fc=.5 Cje=8.063p Mje=.3677 Vje=.75 Tr=33.42n Tf=179.3p Itf=.4 Vtf=4 Xtf=6 Rb=10)

2N3906 / MMBT3906 / PZT3906

PNP General Purpose Amplifier
(continued)

Thermal Characteristics

TA = 25°C unless otherwise noted

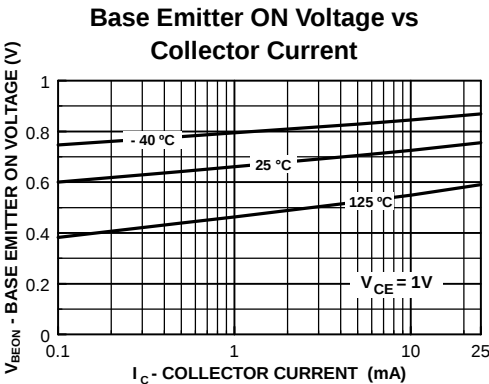
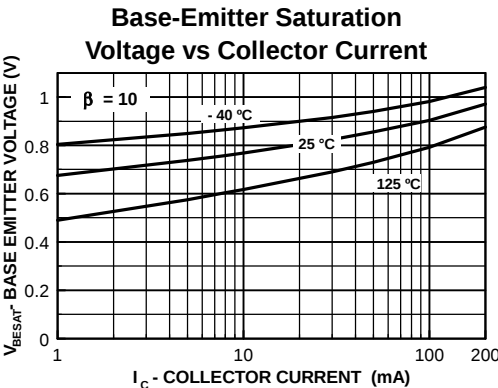
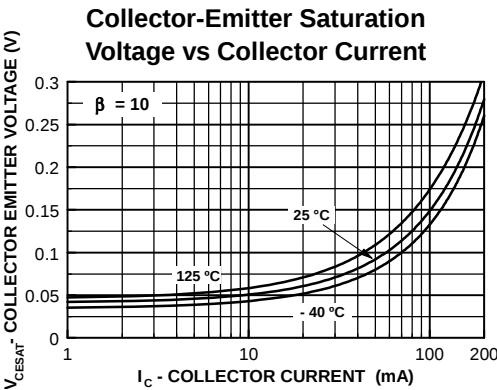
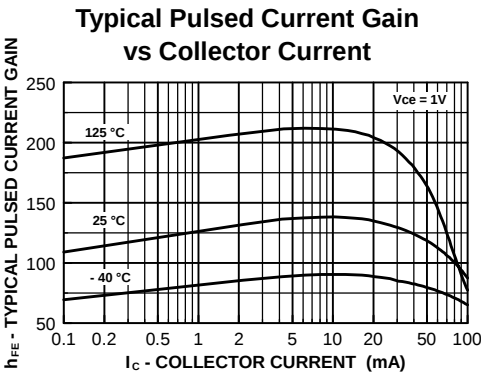
Symbol	Characteristic	Max		Units
		2N3906	*PZT3906	
P _D	Total Device Dissipation Derate above 25°C	625	1,000	mW
		5.0	8.0	mW/°C
R _{θJC}	Thermal Resistance, Junction to Case	83.3		°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	200	125	°C/W

Symbol	Characteristic	Max		Units
		**MMBT3906	MMPQ3906	
P _D	Total Device Dissipation Derate above 25°C	350	1,000	mW
		2.8	8.0	mW/°C
R _{θJA}	Thermal Resistance, Junction to Ambient Effective 4 Die Each Die	357		°C/W
			125	°C/W
			240	°C/W

*Device mounted on FR-4 PCB 36 mm X 18 mm X 1.5 mm; mounting pad for the collector lead min. 6 cm².

**Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

Typical Characteristics

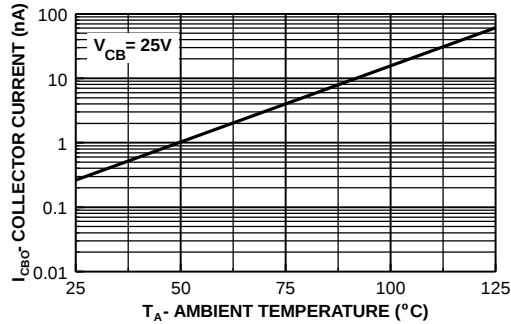


PNP General Purpose Amplifier (continued)

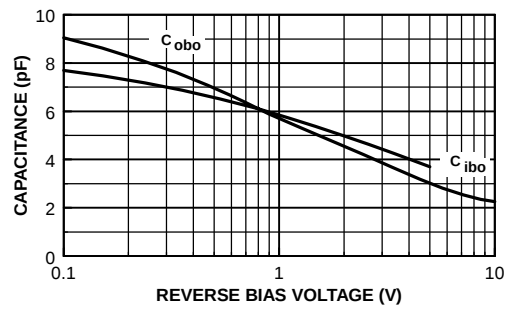
2N3906 / MMBT3906 / PZT3906

Typical Characteristics (continued)

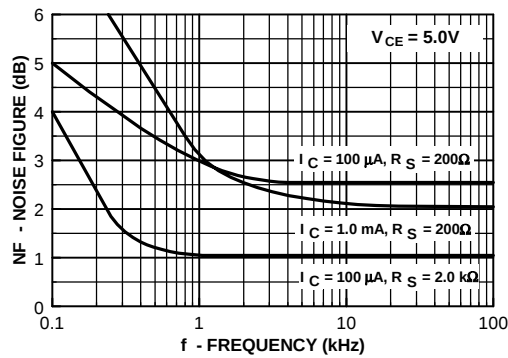
Collector-Cutoff Current
vs. Ambient Temperature



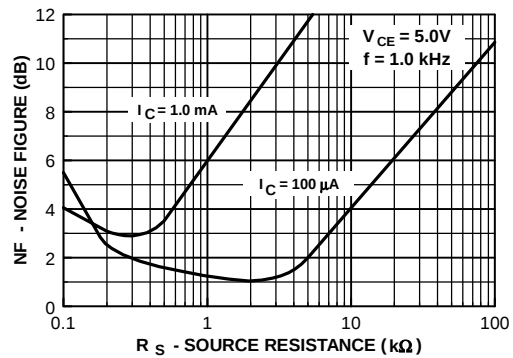
Common-Base Open Circuit
Input and Output Capacitance
vs Reverse Bias Voltage



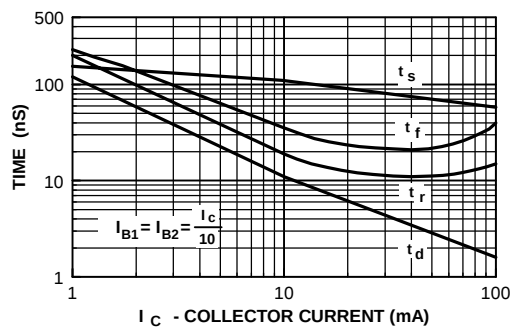
Noise Figure vs Frequency



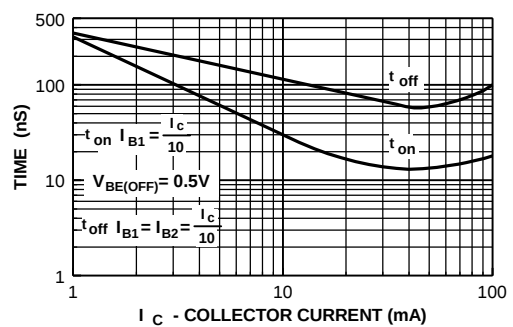
Noise Figure vs Source Resistance



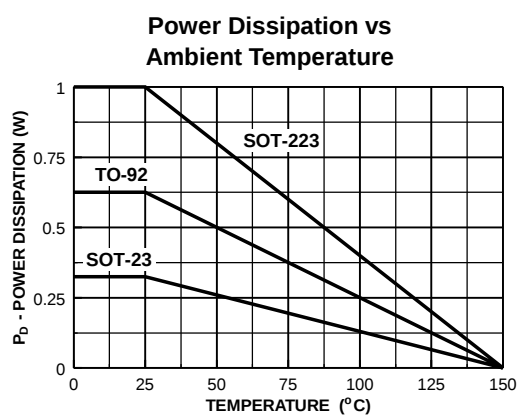
Switching Times
vs Collector Current



Turn On and Turn Off Times
vs Collector Current



Typical Characteristics (continued)



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